Am27C191/Am27C291

Advanced Micro Devices

16,384-Bit (2048x8) High-Performance CMOS PROM

DISTINCTIVE CHARACTERISTICS

- High-speed (25 ns)/Low-Power (60 mA) CMOS EPROM Technology
- Direct plug-in replacement for Bipolar PROMs JEDEC-approved pinout
- Silm 300-mil DIP (Am27C291) or standard 600-mil DIP (Am27C191) packaging available
- 5-Volt ±10% power supplies for both Commercial and Military
- UV-erasable and reprogrammable provides exceptionally high programming yields (Typ. > 99.9%)
- ESD immunity > 2000 V

GENERAL DESCRIPTION

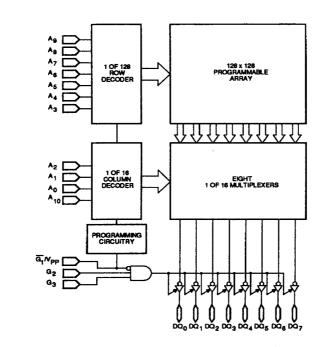
The Am27C191 (2048 words by 8 bits) is a high-performance CMOS programmable read-only memory (PROM).

This device has three-state outputs compatible with lowpower Schottky bus standards capable of satisfying the requirements of a variety of microprogrammable controls, mapping functions, code conversion, or logic replace-

10176A-1

ment. Word-depth expansion is facilitated by both active LOW (\$\overline{G}_1\$) and active HIGH (\$\overline{G}_2\$ and \$\overline{G}_3\$) output enables. This device utilizes proven floating-gate EPROM technology to ensure high reliability, ease of programming, and exceptionally high programming yields. This device is also available in 300-mil lateral center DIP (Am27C291).

BLOCK DIAGRAM



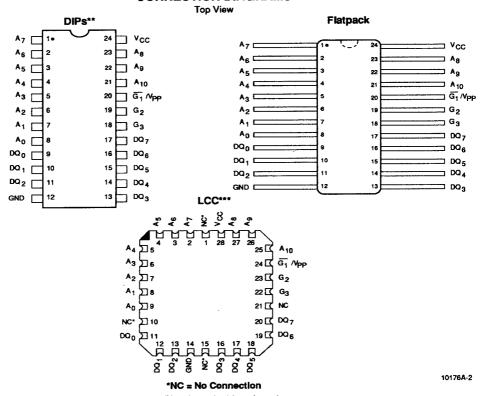
Publication # Rev. Amendment 10176 B /0 Issue Date: January 1989

PRODUCT SELECTOR GUIDE

Part Number	Am27C191-25 Am27C291-25	Am27C191-35 Am27C291-35	Am27C191-45 Am27C291-45
Address Access Time	25 ns	35 ns	45 ns
Operating Range	COM'L	COM, FWIF,	COM'L/MIL*

^{*} Advance Information—Military Products Only.

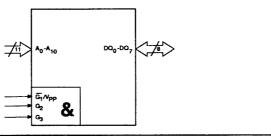
CONNECTION DIAGRAMS



Note: Pin 1 is marked for orientation

- ** Also available in a 24-Pin ceramic windowed DIP. Pinout identical to DIPs.
- *** Also available in a 28-Pin ceramic windowed LCC. Pinout identical to LCC.

LOGIC SYMBOL



10176A-3

Am27C191/Am27C291

ORDERING INFORMATION Am27C191 Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:

a. Device Number

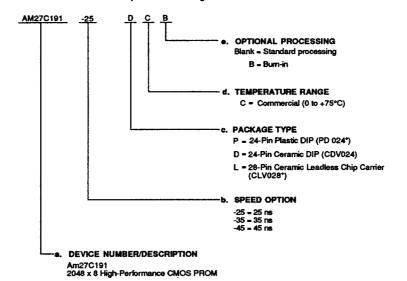
b. Speed Option (if applicable)

c. Package Type

d. Temperature Range

e. Optional Processing

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Valid Combinations					
AM27C191-25					
AM27C191-35	PC, PCB, DC, DCB, LC, LCB				
AM27C191-45					

* Product version in Development, contact HPP Product Marketing.

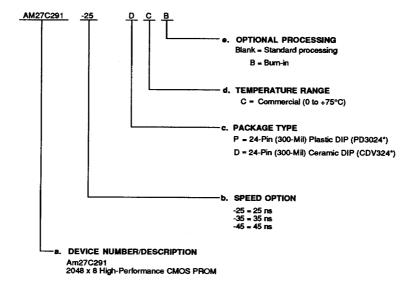
Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations, to check on newly released combinations, and to obtain additional data on AMD's standard military grade products.

ORDERING INFORMATION (Cont'd.) Am27C291 Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) Amb statistical products are available in several packages and op is formed by a combination of: a. Device Number

b. Speed Option (if applicable)
c. Package Type
d. Temperature Range
e. Optional Processing



Valid Combinations				
AM27C291-25				
AM27C291-35	PC, PCB, DC, DCB			
AM27C291-45				

*Product version in Development, contact HPP Product Marketing.

Valid Combinations

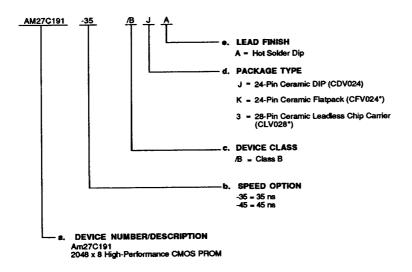
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MILITARY ORDERING INFORMATION Am27C191 APL Products

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AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) is formed by a combination of: s. Device Number
b. Speed Option (if applicable)
c. Device Class

- Package Type Lead Finish



Valid Combinations AM27C191-35 /BJA, /BKA, /B3A AM27C191-45

*Preliminary; Package in Development.

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

Group A Tests

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

MILITARY BURN-IN

Military burn-in is in accordance with the current revision of MIL-STD-883, Test Method 1015, Conditions A through E. Test conditions are selected at AMD's option.

MILITARY ORDERING INFORMATION (Cont'd.) Am27C291 APL Products

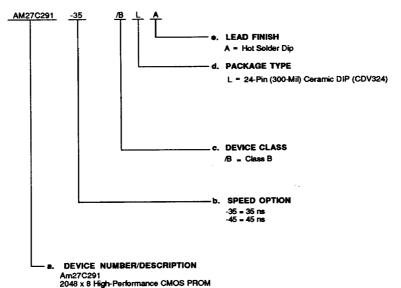
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a. Device Number

b. Speed Option (if applicable)

c. Device Class

- d. Package Type e. Lead Finish



Valid Con	nbinations
AM27C291-35	/BLA
AM27C291-45	1 ""

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

Group A Tests

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

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PIN DESCRIPTION

Address Lines (Inputs)

The 11-bit field presented at the address inputs selects one of 2048 memory locations to be read from.

DQ_a-DQ, Data Port (input/Outputs; Three State)

The outputs whose state represents the data read from the selected memory locations. These outputs are threestate buffers which, when disabled, are in a floating or high-impedance state. These pins provide the data input for programming the memory array.

G, Npp. G2, G1 Output Enable/(Vpp) Programming

Provides direct control of the DQ output three-state buffers. When raised to a voltage > 12.0 V, the G, Npp pin provides the programming power to program the memory array.

Enable =
$$\overline{G}_1 \cdot G_2 \cdot G_3$$

Disable = $\overline{G}_1 \cdot G_2 \cdot G_3$
= $G_1 + \overline{G}_2 + \overline{G}_3$

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	65 to +150°C
Ambient Temperature	
with Power Applied	55 to +125°C
Supply Voltage	0.5 V to +7.0 V
DC Voltage Applied to Outputs	
in High-Impedance State	0.5 V to +7.0 V
DC Programming Voltage (Vpp)	14 V
DC Input Voltage	0.5 V to +7.0 V
Electrostatic Discharge Protection	
(per MIL-STD-883 Method 3015.2)	> 2000 V

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

OPERATING RANGES

Commercial (C) Devices	
Ambient Temperature (T _a)	0 to +75°C
Supply Voltage (V _{cc})	+4.5 V to +5.5 V
Military (M) Devices*	
Case Temperature (T _c)	55 to +125°C
Supply Voltage (V	

Operating ranges define those limits between which the functionality of the device is guaranteed.

DC CHARACTERISTICS over operating ranges unless otherwise specified (for APL Products, Group A, Subgroups 1, 2, 3 are tested unless otherwise noted)

Parameter Symbol	Parameter Description	Test C	conditions	Min.	Max.	Unit
V _{IH}	Input HIGH Voltage	Guaranteed Input HIGH Voltage (Note 1)		2.0		v
V _{IL}	Input LOW Voltage	Guaranteed Ir (Note 1)	nput LOW Voltage		0.8	٧
V _{oH}	Output HIGH Voltage	V _{cc} = Min., 1 _{oH} V _{IN} = V _{IH} or V _{IL}		2.4		v
V _{oL}	Output LOW Voltage	V _{cc} = Min., I _{oL} = 16 mA V _{IN} = V _{IH} or V _{IL}			0.4	v
V _{CL}	Input Clamp Diode Voltage	V _{cc} = Min., I _{IN} = -18 mA		-1.2		V
l _m	Input HIGH Current	V _{cc} = Max., V _{IN} = 5.5 V			10	μА
I,_	Input LOW Current	V _{cc} = Max., V _{IN} = 0.0 V			-10	μА
l _{sc}	Output Short-Circuit Current	V _{cc} = Max. V _{out} = 0.0 V (Note 2)		-20	-90	mA
1	Output Leakage Current	V _{cc} = Max.,	V _{our} = 5.5 V		40	μА
CEX	Output Learage Outlett	V _{g1} = 2.4 V	V _{out} = 0.4 V		-4 0	μА
	Operating Supply Current	V _{cc} = Max.			60	mA
l _{cc}	Operating Supply Current	(Note 3)	All Inputs = V _{IL}			

Notes: 1. V_{IL} and V_{IH} are input conditions of output tests and are not themselves directly tested. V_{IL} and V_{IH} are absolute voltages with respect to device ground and include all overshoots due to system and/or tester noise. Do not attempt to test these values without suitable equipment.

- 2. Not more than one output should be shorted at a time. Duration of the short-circuit test should not exceed one second.
- Operating I_{cc} is measured with all inputs execpt G
 _I switching between V
 _{IL} and V
 _{IH} at a timing interval equal to TAVDQV. The outputs are disabled via G
 _I held at 3.0 V.

^{*} Military product 100% tested at T_c = +25°C, +125°C, and -55°C.

Capacitance*

Parameter Symbol	Parameter Description	Test Conditions	Тур.	Unit
	Input Capacitance (G ₁ /V _{pp})		9	
C _M	Input Capacitance (All Others)	$V_{cc} = 5.0 \text{ V}, T_{s} = 25^{\circ}\text{C}$ $V_{ts}/V_{out} = 2.0 \text{ V @ f} = 1 \text{ MHz}$	5	pF
Cour	Output Capacitance		8	p₹

^{*}These parameters are not 100% tested, but are evaluated at initial characterization and at any time the design is modified where capacitance may be affected.

SWITCHING CHARACTERISTICS over operating range unless otherwise specified (for APL Products, Group A, Subgroups 9, 10, 11 are tested unless otherwise noted*)

			Am27C191/Am27C291						
		-25 -35 COM'L Only COM'L/MIL		j -35		-45 COM'L/MIL			
				'L/MIL					
No.	Parameter Parameter No. Symbol Description		Min.	Max.	Min.	Max.	Min.	Max.	Unit
1	TAVDQV	Address Valid to Output Valid Access Time		25		35		45	ns
2	TGVDQZ	Delay from Output Enable Valid to Output High Impedance (Note 2)		20		20		25	ns
3	TGVDQV	Delay from Output Enable Valid to Output Valid (Note 3)		20		20		25	ns

See Switching Test Circuits.

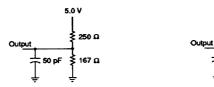
Notes: 1. Tests are performed with input transition time of 5 ns or less, timing reference levels of 1.5 V, and input pulse levels of 0 to 3.0 V using test load in diagram A.

TGVDQZ is measured at steady-state HIGH output voltage -0.5 V and steady-state LOW output voltage +0.5 V output levels using the test load in diagram B.

TGVDQV is measured at steady-state output voltage minus 0.5 V for Hi–Z to LOW and steady-state output voltage plus 0.5 V for Hi–Z to HIGH output levels using the test load in diagram A.

* Subgroups 7 and 8 apply to functional tests.

SWITCHING TEST CIRCUITS



A. Output Load for all AC tests except TGVDQZ

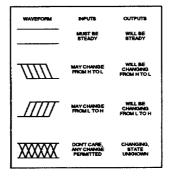
B. Output Load for TGVDQZ

250 Ω

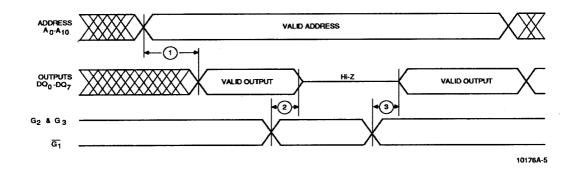
Notes: 1. All device test loads should be located within 2" of device output pin.

2. Load capacitance includes all stray and fixture capacitance.

SWITCHING WAVEFORMS KEY TO SWITCHING WAVEFORMS



KS000010



Am27C191/Am27C291 CMOS PROM PROGRAMMING PROCEDURE

Programming Technique

Advanced Micro Devices' high-performance CMOS PROM circuits have been designed to use a programming algorithm which minimizes the requirements on the programmer, yet allows the circuit to be programmed quickly and reliably. Specifically, the following sequence of events must take place:

- 1) V_{cc} power is applied to the device;
- 2) The device outputs are disabled;

- 3) The appropriate address is selected;
- 4) The appropriate byte-wide pattern is applied to all outputs:
- 5) The G, N_{pp} pin is pulsed to 13.5 V for 1 ms;
- The device is enabled and the byte sensed to verify that correct programming has occurred.
- In the event that the data does not verify, the sequence of 4 through 6 could be repeated up to 25 times;
- 8) At the conclusion of initial programming, the sequence of 4 and 5 should be repeated for over-programming using a V_{cc} = 5.0 V, and G,V_{pp} pulse width equal to twice the sum of initial programming pulse times;
- The sequence of 2 through 6 must be repeated for each address to be programmed;
- At the conclusion of programming, the device should be verified for correct data at all addresses with two V_{cc} supply voltages (V_{cc} = 6.0 and V_{cc} = 4.2 V).

Notes on Programming

- The unprogrammed or erased state of all enabled outputs is HIGH.
- All delays between edges are specified from the completion of the first edge to the beginning of the second edge; i.e., not the midpoints (10% or 90% of specified waveform).
- During t_v, the output may be switched to appropriate loads for proper verification of specified V_{ot} and V_{ot} levels.
- 4) Due to the potential for fast voltage transitions of the outputs, it is advisable to provide low-impedance connections to the device's V_{cc} and ground pins and to ensure adequate decoupling at the device pins.

Erasure Characteristics

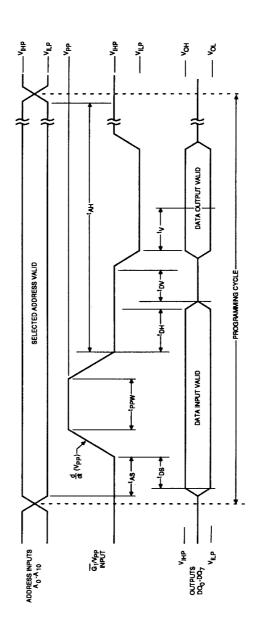
In order to fully erase all memory locations, it is necessary to expose the memory array to an ultraviolet light source having a wavelength of 2537Å. The minimum recommended dose (UV intensity times exposure time) is 15 Wsec/cm². For a UV lamp with a 12 mW/cm² power rating, the exposure time would be approximately 30 minutes. The device should be located within 1 inch of the source in direct line.

It should be noted that erasure may begin with exposure to light having wavelengths less than 4000Å. To prevent exposure to sunlight or fluorescent lighting from resulting in partial erasure, an opaque label should be affixed over the window after programming.

PROGRAMMING PARAMETERS (T_A = 25°C ±5°C)

Parameter Symbol	Parameter Description		Min.	Max.	Unit
		Initial Programming	5.75	6.25	v
V _{ccP}	Power Supply during Programming	Over-Programming	4.75	5.25]
I _{ccr}	V _{cc} Supply Current during Programmi	ng		90	mA
V _{pp}	Programming Voltage		13.0	14.0	V
I _{pp}	V _{PP} Supply Current during Programmi	ng		30	mA
V _{HP}	Input HIGH Level during Programming and Verify		2.4	5.5	V
V _{ILP}	Input LOW Level during Programming and Verify		0	0.45	V
Vol	Output LOW Voltage during Verify			0.45	v
V _{oH}	Output HIGH Voltage during Verify		2.40		V
dV _{pp} /dt	Rate of $\overline{G}_i \mathcal{N}_{pp}$ Voltage Change (Rise and Fall Times)		5	10	V/µs
t _{PPW}	V _{PP} Programming Pulse Width	Initial Programming Pulse	0.95	1.05	ms
t _{AS}	Address Valid to V _{PP} (HIGH) Setup Ti	me	1.0		μs
t _{an}	V _{pp} (LOW) to Address Change Hold 1	lime .	1.0		μs
t _{os}	Data Valid to V _{pp} (HIGH) Setup Time		1.0		μs
t _{on}	V _{PP} (LOW) to Data Change Hold Time		1.0		μs
t _{DV}	Delay from Data to Output Enable (LOW) for Verification		1.0		μs
ţ,	Delay from Output Enable (LOW) to Verification Strobe		100		ns

PROGRAMMING WAVEFORMS



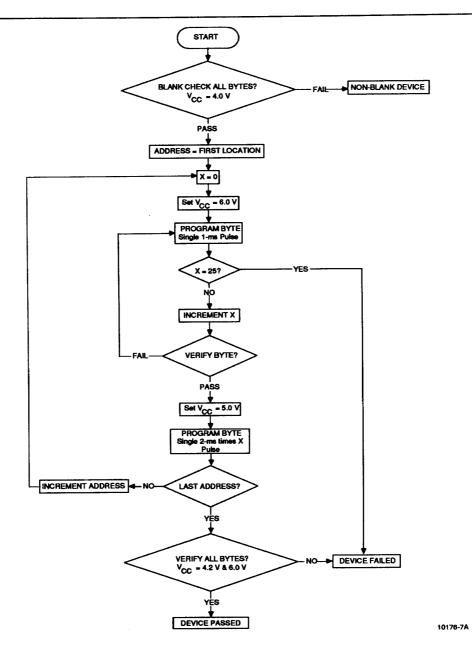


Figure 1. Programming Flow

TECHDOC 794C

Am27C191/Am27C291